AUG 3 1 2001 Page 1 of 1								
Subst. Form PTO-1449 APPLICANT'S(S') INFORMATION DISCLOSURE STATEMENT			Atty. Docket No.: D/A0597		Serial	Serial No.: 09/725,836		
			XER 2 0368 Applicant(s): Michel A. Rosa, et al.					
			Filing Date:	Grou	Group: 2841			
U.S. PATENT DOCUMENTS								
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OTHER ART								
M	~AR	Deborah S. Patterson, Flip Chip Technologies, 3701 E. University Drive, Phoenix, AZ, Seminar, A Comparison of Popular Flip Chip Bumping Technologies (Test, Assembly & Packaging Conference (InterPACK '97), in Kona, HW, 1997).						
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Examiner:	niner: Jinher Lee Date Considered: 3ho/02						0/02	
* EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if in conformance and not considered. Include copy of this form with next communication to applicant.								